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Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

	Application Number	10/040,963
TRANSMITTAL	Filing Date	1/5/02
FORM	First Named Inventor	Steven Teig
(to be used for all correspondence after initial filing)	Group Art Unit	2825
	Examiner Name	Vuthe Siek
Total Number of Pages in This Submission *	Attorney Docket Number	SPLX.P0023

	Enclosures (Check all that apply)						
Fee Transmittal Form	Assignment Papers (for an application)	After A	Allowance Communication to				
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Response to Missing Parts Incomplete Application	1						
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	GIGNATURE OF APPLICANT, ATTORNEY,	OR AGENT	00 AY				
Firm <i>Or</i> Individual name	ani Adeli, Reg. No. 39,585 of Stattler Jo	nansen & Ad	deli LLP 👸 🖒 🣆				
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Date April 28, 2003							
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PATENT Docket No. SPLX.P0023

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of:

Steven Teig

Serial No.:

10/040,963

Filing Date:

1/5/02

For:

**ROUTING METHOD AND** 

APPARATUS

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. § 1.97

Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir:

Pursuant to 37 C.F.R. § 1.97 and § 1.98, applicants submit for consideration in the above-identified application the documents listed on the attached Form PTO-1449. Copies of the documents are also submitted herewith. The Examiner is requested to make these documents of record.

This Information Disclosure Statement is submitted: After receipt of a first Office Action on the merits but before a final Office Action or Notice of Allowance. Applicants would appreciate the Examiner initialing and returning the Form PTO-1449, indicating that the information has been considered and made of record herein.

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This Information Disclosure Statement under 37 C.F.R. § 1.97 is not to be construed as a representation that: (i) a complete search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the above information constitutes

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Dated: April 28, 2003

prior art to the subject invention.

Respectfully submitted,

3y: **/** /

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## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet 1 of

Application Number	10/040,963
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First Named Inventor	Steven Teig
Group Art Unit	2825
Examiner Name	Vuthe Siek
Attorney Docket Number	SPLX.P0023

		·		U.S. PATENT DOCUMENT	S	
Examiner* Cite U.S. Patent Document No.1 Number Kind Code (if known)		Number Kind Code <sup>2</sup> of Cited Document		Date of Publication MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
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Application Number	10/040,963
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First Named Inventor	Steven Teig
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Examiner Name	Vuthe Siek
Attorney Docket Number	SPLX.P0023

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	Substitute for form 1	1449A/F	TO	Application Number	10/040,963
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STATEMENT BY APPLICANT				Group Art Unit	2825
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Sheet	3	of	3	Attorney Docket Number	SPLX.P0023

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Examiner* Cite Foreign Patent Document Initials No.1 Foreign Patent Document Kind Code Office³ Number⁴ (if known)⁵			ŀ	Kind Code	Name of Patentee or Applicant of Cited Document	Date of Publication MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>			
	53.	JP	64-15947		Ouchi	01-19-89					
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First Named Inventor	Steven Teig
Group Art Unit	2825
Examiner Name	Vuthe Siek
Attorney Docket Number	SPLX.P0023

		NON PATENT LITERATURE DOCUMENTS	
Examiner* Initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>6</sup>
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